Small Gap MICROMEGAS MicroBulk

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Fabrication process

Copper 5µm

Kapton (25 or 12,5µm)

1) Two thin copper foils are glued on each side of a Kapton foil.



Performances

F.J. Iguaz et al., JINST 7P04007(2013) T. Dafni et al., NIM A608, p259 (2009)

Energy resolution (10% FWHM @ 6 keV)

Low intrinsic background & better particle recognition \checkmark







2) Holes are done removing the copper by a standard lithographic process.



Low mass detector

Very flexible structure





<u> µBulk 25µm (Ø30µm & pitch 100µm)</u>

Simulation

Lorentz simulation of drift and amplification fields

Variation of pressure (Ar+10%iC4H10)

<u>µBulk 12,5µm (Ø25µm & pitch 80µm)</u>

Simulation

Lorentz simulation of drift and amplification fields

Variation of %iC4H10

Measurement with a ⁵⁵Fe source(@5,9KeV)



Mesh Pillars Anode

3) The kapton is etched and partially removed in order to create tiny pillars in the shadow part of the mesh below the copper mesh.

S. Andriamonje et al., JINST 5P02001 (2010)



Variation % iC4H10+Ar

Measurement with a ⁵⁵Fe source(@5,9KeV)







Umesh=-280V & Udrift=-340



Gap 25 vs 12,5µm

Ar+ 10% iC4H10:Measurement with a ⁵⁵Fe source(@5,9KeV)







Conclusions

Microbulks of 25 and 12.5 µm have been manufactured and tested with SUCCESS.

Gains greater than 10⁴ in Argon-Isobutane mixtures have been obtained for the 25 μ m gaps and 8×10³ for the 12.5 μ m.

Energy resolutions as low as 11% and 15% for the 25 and 12.5µm respectively have been reached even in the hole diameter of the microbulk is not optimal (hole_{\emptyset} < d_{qap}) and is reaching the limit of the fabrication technique.

Studies of performance as a function of pressure and gas will be pursued.